

Alternate Backside Patterns (May be supplied with any pattern shown.)

UNLESS OTHERWISE SPECIFIED,
DIMENSIONS ARE IN mm (Inches)
PER ANSI YAE, IN MM (Inches)
TOLERANCES ARE:
DECIMAL ANGLE
.XX ±.12 (.005) ±1/2'
.XXX ±.05 (.002)

MATERIAL (SD)

See Notes

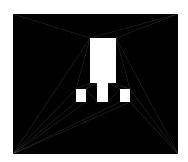
FINISH: See Notes Notes:
Base Metal - Copper Olin 194
Lead Finish
Basic PN - Sn/Pb Sn =>80%
Z option - 100% Matte Sn - .01 (.0004) thk min

- Do Not Scale Hardcopy -

Caution: The Land Patterns and Solder Mask shown are generic for this package. Refer to product data sheet for any required variations specific to an application.



Generic Land Pattern This land pattern is applicable to both backside patterns shown.



Scale 4:1

- Generic Solder Mask Opening -This solder mask is applicable to both backside patterns shown.

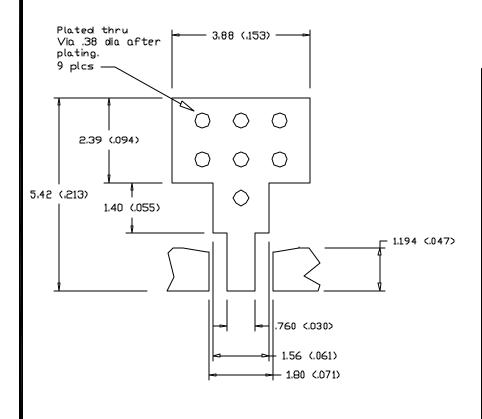


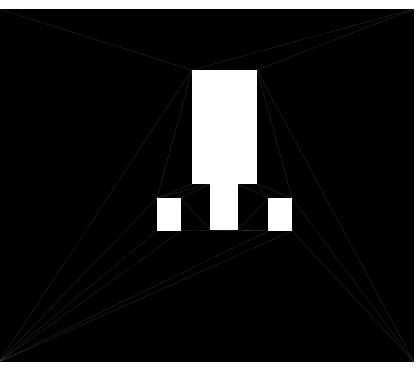
Package Type:

SOT-89 4 Ld

SMDI Package Type: XXX-XX89

Iwg No. | Sht | REV | 1 of 2 | J



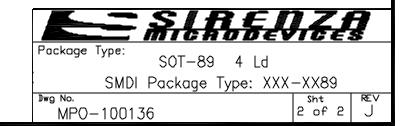


Scale 10:1

Generic Land Pattern This land pattern is applicable to both backside patterns shown.

Scale 10:1

Generic Solder Mask Opening This solder mask is applicable to both backside patterns shown.



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